## **LISTING OF CLAIMS:**

This listing of claims will replace all prior versions, and listings, of claims in the application:

Claim 1 (Currently Amended):

A method of inspecting patterns,

comprising the steps of:

picking up a first pattern formed on a substrate to produce a first image; storing the first image;

picking up a second pattern that is also formed on the substrate so as to have naturally the same shape as the first pattern, thereby producing a second image;

aligning the stored-first image and the second image with an accuracy of one pixel unit;

image are aligned with one pixel unit, adjusting a brightness of at least one of the stored first image and the second image to locally match a brightness of the first image with a brightness of the second image; and

comparing the first and second images aligned and locally-matched in brightness to detect a defect of the patterns.

Claim 2 (Currently Amended): A method according to claim 1, wherein the step of performing local gradation conversionadjusting the brightness of at least one of the stored first image and the second image to locally-match the brightness of the first image with the brightness of the second image is performed by means of a linear conversion having a gain and an offset so that the brightness of

2

the first image can be made substantially equal to the brightness of the second image.

## Claim 3 (Canceled):

Claim 4 (Previously Presented): A method according to claim 1, wherein a surface of the substrate is covered with an optically transparent film; and wherein a surface of the optically transparent film is processed to be flat.

Claim 5 (Previously Presented): A method according to claim 1, wherein the step of picking up the first pattern and the step of picking up the second pattern are performed optically.

Claim 6 (Previously Presented): A method according to claim 1, wherein the step of picking up the first pattern and the step of picking up the second pattern are performed by use of an electron beam.

Claim 7 (Currently Amended): A method of inspecting a pattern, comprising the steps of:

picking up a first pattern formed on a substrate to produce a first image; storing the first image;

picking up a second pattern that is formed on the substrate so as to have naturally the same shape as the first pattern, thereby producing a second image;

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aligning the first image and the second image with an accuracy of one pixel unit;

after the first image and second image are aligned with one pixel unit,
adjusting a brightness of at least one of the first image and the second image by
collectively filtering the first image and the second image to match the brightness of
the two images;

performing lecal-gradation conversion of at least one of the stored first image
and the second image to lecally-match a brightness of the stored first image with a
brightness of the second image; and aligning the stored first image and the second
image with an accuracy of one pixel unit, and then

comparing the first and second images to detect a defect and to obtain
features of the detected defect; and
displaying information of the features of the detected defect on a screen.

Claims 8-11 (Canceled):

Claim 12 (Currently Amended): A method according to claim 447, wherein the step of aligning the stored-first image and the second image is performed for each of a plurality of pixels of the stored-first image and the second image.

Claim 13 (Currently Amended): A method according to claim 87,

\_\_wherein the substrate is a semiconductor wafer;

wherein the semiconductor wafer has a surface covered with an optically transparent film; and

wherein a surface of the optically transparent film is processed to be flat.

Claim 14 (Currently Amended): A method according to claim 117, wherein the step of performing local said gradation conversion of at least one of the stored first image and the second image is performed within each of a plurality of local areas of the at least one of the stored first image and the second image.

Claim 15 (Currently Amended):

An apparatus for inspecting defects of patterns, comprising:

image pick-up means for picking up a first pattern formed on a substrate and a second pattern that is also formed on the substrate so as to have naturally the same shape as the first pattern, thereby producing a first image of the first pattern and a second image of the second pattern;

storage means for storing the first image;

alignment means for aligning the stored-first image and the second image with an accuracy of one pixel unit;

brightness conversion means for adjusting a brightness of at least one of the first image and the second image by collectively filtering the first and second images to match a brightness of the two images;

local-gradation conversion means for performing local-gradation conversion of at least one of the stored-first image and the second image to locally-match a brightness of the stored-first image with a brightness of the second image;

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defect detection means for comparing the aligned-first and second images, at least one of which has a brightness which has been corrected by the local gradation conversion means, thereby detecting defects of the patterns; and

output means for producing information of the defects of the patterns detected by the defect detection means.

## Claim 16 (Canceled):

Claim 17 (Currently Amended): An apparatus according to claim 15, wherein the local-gradation conversion means corrects brightness values of the at least one of the first and second images so as to locally-match a brightness of the first image with a brightness of the second image by performing a linear conversion having a gain and an offset.

Claim 18 (Previously Presented):

An apparatus according to claim 15, wherein the image pick-up means optically picks up the first pattern and the second pattern.

Claim 19 (Previously Presented):

An apparatus according to claim 15, wherein the image pick-up means picks up the first pattern and the second pattern by use of an electron beam.

Claim 20 (Previously Presented):

An apparatus according to

claim 15, wherein the output means displays on a screen information of a brightness,

a local contrast, or a local average of the first and second images.

Claim 21 (Currently Amended):

An apparatus according to claim 15,

wherein the local-gradation conversion means corrects the brightness of the at least

one of the stored first image and the second image after the alignment means has

aligned the stored-first image and the second image with the accuracy of one pixel

unit.

Claim 22 (Currently Amended):

An apparatus for\inspecting defects

of a plurality of patterns formed on a substrate so as to have naturally the same

shape, comprising:

table means on which the substrate is placed, and which can be moved in an

X-Y plane;

image pick-up means for picking up the patterns of the substrate placed on

the table means to produce images of the patterns;

proposed-defects extracting means for processing the images of the patterns

when the substrate placed on the table means is continuously moved, after the

images of the patterns have been aligned with an accuracy of one pixel unit, and at

least one of the images of the patterns has been subjected to lecal-gradation

conversion to lecally-match a brightness of the at least one of the images with a

brightness of at least one other one of the images and the images of the patterns

7

have been aligned with an accuracy of one pixel unit, thereby extracting proposed defects of the patterns;

defect detection means for detecting true defects from the proposed defects of the patterns that have been extracted by the proposed-defects extraction means; and

output means for producing information of the true defects detected by the defect detection means.

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Claim 23 (Previously Presented):

An apparatus according to

claim 22, wherein the proposed-defects extraction means further estimates certainty information of the extracted proposed defects based on at least one of a brightness, a local contrast, and a local average of the images of the patterns.

Claim 24 (Currently Amended):

An apparatus according to claim 22,

further comprising:

storage means for storing the images of the patterns produced by the image pick-up means;

alignment means for aligning the images of the patterns stored in the storage means and the images of the patterns produced by the image pick-up means with an accuracy of one pixel unit; and

brightness filter means for adjusting a brightness of at least one of the images aligned by the alignment means by collectively filtering all images of the patterns to match a brightness of the images;

local-gradation correction means for correcting a brightness of at least one of the images aligned by the alignment means by performing gradation conversion of least one of the images of the patterns to match a brightness of the images;

wherein the proposed-defects extraction means extracts the proposed defects of the patterns from the aligned images, at least one of which has a brightness which has been corrected by the local gradation conversion means, and estimates certainty information of the extracted proposed defects.

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Claim 25 (Previously Presented):

An apparatus according to

claim 24, wherein the alignment means aligns the images of the patterns stored in the storage means and the images of the patterns produced by the image pick-up means with an accuracy of one pixel unit within each of a plurality of small divisions of the images of the patterns.

Claim 26 (Currently Amended): An apparatus according to claim 24, wherein the local gradation conversion means corrects a brightness of the at least one of the images aligned by the alignment means within each of a plurality of local areas of the at least one of the images aligned by the alignment means.

Claim 27 (Currently Amended):

An apparatus for inspecting defects of patterns, comprising:

image pick-up means for picking up a first pattern formed on a substrate and a second pattern that is formed on the substrate so as to have naturally the same

second image of the second pattern;

storage means for storing the first image;

defect detection means for correcting at least one of the stored-first image and the second image by at least performing gradation conversion of at least one of the stored-first image and the second image to∖locally-match a brightness of the stored first image with a brightness of the second image, and aligning the stored first image and the second image with an accuracy of one pixel unit, collectively filtering the first image and the second image to match a brightness of the first image with a brightness of the second image, comparing the first image and the second image aligned and matched in brightness to detect defects after the at least one of the stored first image and the second image has been cerrected, and then estimating information of the detected defects; and

shape as the first pattern, thereby producing a first image of the first pattern and a

display means for displaying on a screen the defects detected by the defect detection means, and the information of the detected defects.

Claim 28 (Currently Amended):

An apparatus, according to claim 27,

wherein said defect detection means includes:

alignment means for aligning the stored first image and the second image with an accuracy of one pixel; and

lecal-gradation conversion means for performing lecal-gradation conversion to correct a brightness of at least one of the stored-first image and the second image;

wherein the defect detection means compares the aligned first and second images, at least one of which has a brightness which has been corrected by the local gradation conversion means, thereby detecting the defects.

Claim 29 (Previously Presented):

An apparatus according to claim 27, wherein the image pick-up means optically picks up the first and second patterns.

Claim 30 (Previously Presented):

An apparatus according to claim 27, wherein the image pick-up means picks up the first and second patterns by use of an electron beam.

Claim 31 (Currently Amended): A method according to claim 1, wherein the local-gradation conversion minimizes a sum of squares of differences between the brightness of the first image and the brightness of the second image within each of a plurality of local areas of the first image and the second image.

Claim 32 (Currently Amended): A method according to claim 7, wherein the local-gradation conversion minimizes a sum of squares of differences between a brightness of the first image and a brightness of the second image within each of a plurality of local areas of the first image and the second image.

Claim 33 (Currently Amended): A method according to claim 814, wherein the local-gradation conversion minimizes a sum of squares of differences

between a brightness of the first image and a brightness of the second image within each of a plurality of local areas of the first image and the second image.

Claim 34 (Currently Amended): An apparatus according to claim 15, wherein the local-gradation conversion minimizes a sum of squares of differences between a brightness of the first image and a brightness of the second image within each of a plurality of local areas of the first image and the second image.

Claim 35 (Currently Amended): An apparatus according to claim 22, wherein the local-gradation conversion minimizes a sum of squares of differences between a brightness of one of the images of the patterns stored in the storage means and a brightness of one of the images of the patterns produced by the image pick-up means within each of a plurality of local areas of the one of the images of the patterns stored in the storage means and the one of the images of the patterns produced by the image pick-up means.

Claim 36 (Currently Amended): An apparatus according to claim 27, wherein the local-gradation conversion minimizes a sum of squares of differences between a brightness of the first image and a brightness of the second image within each of a plurality of local areas of the first image and the second image.